

Session Program

9-11 Apr 2025

4th BIC In-person Workshop

Modules

Building 241, D172

Wednesday 9 April

12:00

Modules

Session | **Location:** Building 241, D172 | **Convener:** Manoj Jadhav

12:00–12:20

Wire bond map, wire bondability, Handling

Speakers

Forest Martinez-Mckinney, Kirsten Affolder, Vitaliy Fadeyev

12:20–12:40

Handling, Carrier tools

Speakers

Forest Martinez-Mckinney, Kirsten Affolder, Vitaliy Fadeyev

12:40–13:00

9-chip PCB testing

Speaker

Bobae Kim

13:00–13:20

Overview of AstroPix performance

Speaker

DANIEL P. VIOLETTE

13:30

13:30

15:00

Modules: & Wafers: Schedule Review

Session | **Location:** Building 241, D172 | **Convener:** Manoj Jadhav

Thursday 10 April

15:30

17:00

Modules: & Wafers

Session | **Location:** Building 241, D172 | **Convener:** Manoj Jadhav

Friday 11 April

09:00
10:00

Modules: & Wafers
Session | **Location:** Building 241, D172